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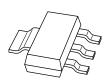
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Kind regards,

Team Nexperia



PBHV8540Z500 V, 0.5 A NPN high-voltage low V_{CEsat} (BISS) transistorRev. 02 - 14 January 2009Product data sheet

1. Product profile

1.1 General description

NPN high-voltage low V_{CEsat} Breakthrough In Small Signal (BISS) transistor in a SOT223 (SC-73) medium power Surface-Mounted Device (SMD) plastic package.

PNP complement: PBHV9040Z.

1.2 Features

- High voltage
- Low collector-emitter saturation voltage V_{CEsat}
- High collector current capability I_C and I_{CM}
- High collector current gain (h_{FE}) at high I_C
- AEC-Q101 qualified

1.3 Applications

- Electronic ballast for fluorescent lighting
- LED driver for LED chain module
- LCD backlighting
- High Intensity Discharge (HID) front lighting
- Automotive motor management
- Hook switch for wired telecom
- Switch mode power supply

1.4 Quick reference data

Table 1.	Quick reference data					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{CESM}	collector-emitter peak voltage	$V_{BE} = 0 V$	-	-	500	V
V_{CEO}	collector-emitter voltage	open base	-	-	400	V
I _C	collector current		-	-	0.5	А
h _{FE}	DC current gain	V _{CE} = 10 V; I _C = 50 mA	100	200	-	



2. Pinning information

Pinning		
Description	Simplified outline	Graphic symbol
base		
collector		2, 4
emitter		1
collector		']
		3 sym016
	Description base collector emitter	Description Simplified outline base 4 collector 4 emitter 4

3. Ordering information

Table 3. Ordering information						
Type number	Package)				
	Name	Description	Version			
PBHV8540Z	SC-73	plastic surface-mounted package with increased heatsink; 4 leads	SOT223			

4. Marking

Table 4.	Marking codes	
Type num	iber	Marking code
PBHV854	ΟZ	V8540Z

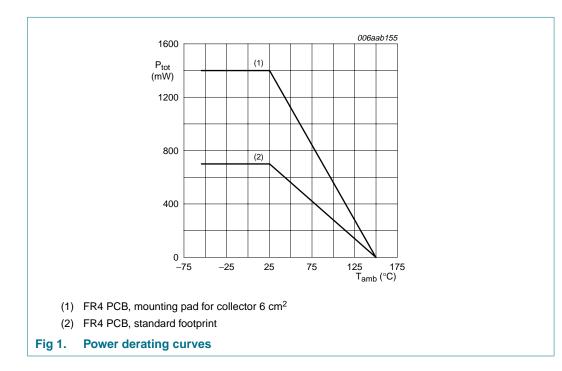
500 V, 0.5 A NPN high-voltage low V_{CEsat} (BISS) transistor

5. Limiting values

Symbol V _{CBO}	Parameter collector-base voltage	Conditions open emitter	Min	Max	Unit
	•	open emitter			
	II 1 10 II	1	-	500	V
V _{CEO}	collector-emitter voltage	open base	-	400	V
V _{CESM}	collector-emitter peak voltage	$V_{BE} = 0 V$	-	500	V
V _{EBO}	emitter-base voltage	open collector	-	6	V
I _C	collector current		-	0.5	А
I _{CM}	peak collector current	single pulse; $t_p \leq 1 ms$	-	1	А
I _{BM}	peak base current	single pulse; $t_p \leq 1 ms$	-	200	mA
P _{tot}	total power dissipation	$T_{amb} \le 25 \ ^{\circ}C$	[1] _	0.7	W
			[2]	1.4	W
Tj	junction temperature		-	150	°C
T _{amb}	ambient temperature		-55	+150	°C
T _{stg}	storage temperature		-65	+150	°C

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and mounting pad for collector 6 cm².



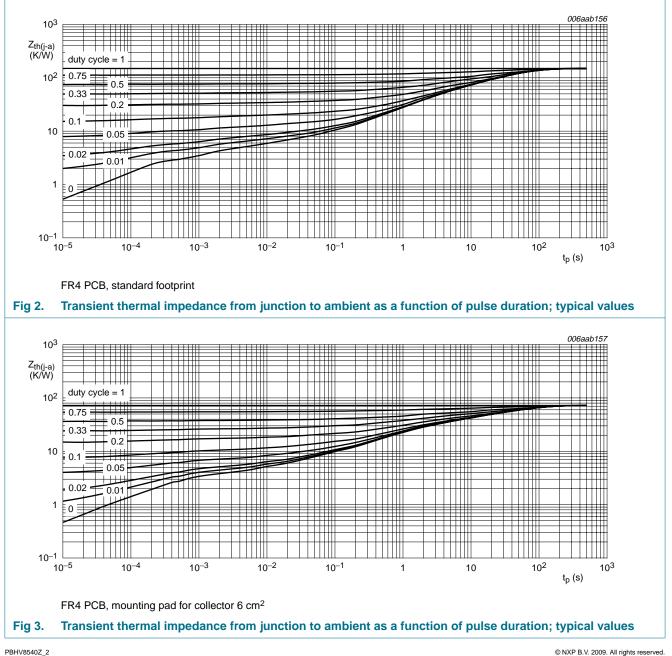
500 V, 0.5 A NPN high-voltage low V_{CEsat} (BISS) transistor

6. Thermal characteristics

Table 6.	Thermal characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R _{th(j-a)}	thermal resistance from	in free air	<u>[1]</u> -	-	175	K/W
junction to an	junction to ambient		[2] _	-	89	K/W
R _{th(j-sp)}	thermal resistance from junction to solder point		-	-	20	K/W

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and mounting pad for collector 6 cm².



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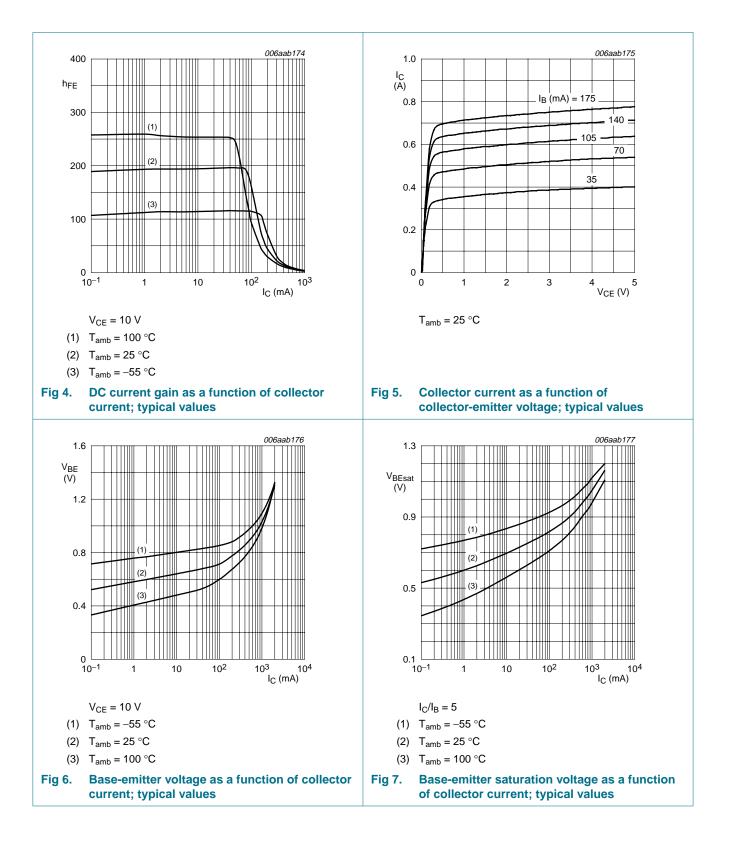
7. Characteristics

Table 7. T _{amb} = 25 °	Characteristics °C unless otherwise specia	fied.				
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
I _{CBO}	collector-base cut-off	$V_{CB} = 320 \text{ V}; I_E = 0 \text{ A}$	-	-	100	nA
	current	$\label{eq:VCB} \begin{array}{l} V_{CB} = 320 \; V; \; I_E = 0 \; A; \\ T_j = 150 \; ^\circ C \end{array}$	-	-	10	μA
I _{CES}	collector-emitter cut-off current	$V_{CE} = 320 \text{ V}; \text{ I}_{C} = 0 \text{ A}$	-	-	100	nA
I _{EBO}	emitter-base cut-off current	$V_{EB} = 4 \text{ V}; I_C = 0 \text{ A}$	-	-	100	nA
h _{FE}	DC current gain	V _{CE} = 10 V				
		I _C = 50 mA	100	200	-	
		I _C = 100 mA	80	150	-	
		I _C = 300 mA	[<u>1]</u> 10	20	-	
V _{CEsat}	collector-emitter saturation voltage	$I_{C} = 100 \text{ mA}; I_{B} = 10 \text{ mA}$	-	100	200	mV
		$I_{C} = 100 \text{ mA}; I_{B} = 20 \text{ mA}$	-	60	90	mV
		$I_{C} = 300 \text{ mA}; I_{B} = 60 \text{ mA}$	-	135	250	mV
V _{BEsat}	base-emitter saturation voltage	$I_{C} = 300 \text{ mA}; I_{B} = 60 \text{ mA}$	<u>[1]</u> _	0.91	1.1	V
f _T	transition frequency	$V_{CE} = 10 \text{ V}; \text{ I}_{C} = 100 \text{ mA};$ f = 100 MHz	-	30	-	MHz
C _c	collector capacitance	$\label{eq:VCB} \begin{array}{l} V_{CB} = 20 \; V; \; I_E = i_e = 0 \; A; \\ f = 1 \; MHz \end{array}$	-	4	-	pF
C _e	emitter capacitance	$\label{eq:Veb} \begin{array}{l} V_{EB}=0.5 \text{ V}; \text{ I}_{C}=\text{i}_{c}=0 \text{ A};\\ \text{f}=1 \text{ MHz} \end{array}$	-	165	-	pF
t _d	delay time	$V_{CC} = 6 \text{ V}; \text{ I}_{C} = 0.5 \text{ A};$	-	50	-	ns
t _r	rise time	$I_{Bon} = 0.1 \text{ A}; I_{Boff} = -0.1 \text{ A}$	-	6200	-	ns
t _{on}	turn-on time		-	6250	-	ns
t _s	storage time		-	800	-	ns
t _f	fall time		-	2200	-	ns
t _{off}	turn-off time		-	3000	-	ns

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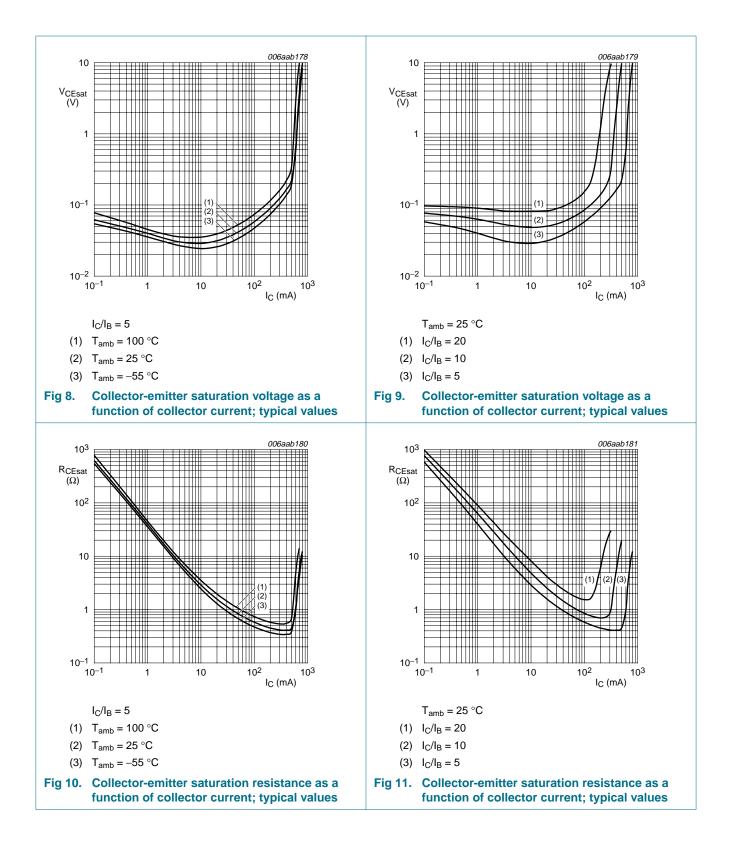
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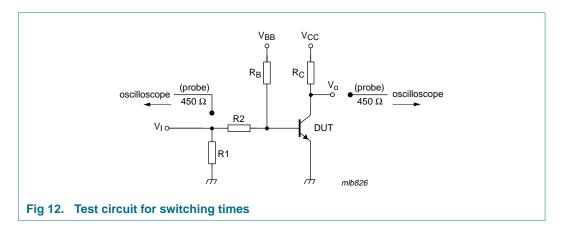
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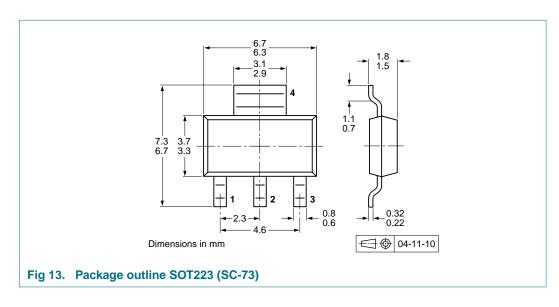
8. Test information



8.1 Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q101* - *Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

9. Package outline



10. Packing information

Table 8. Packing methods

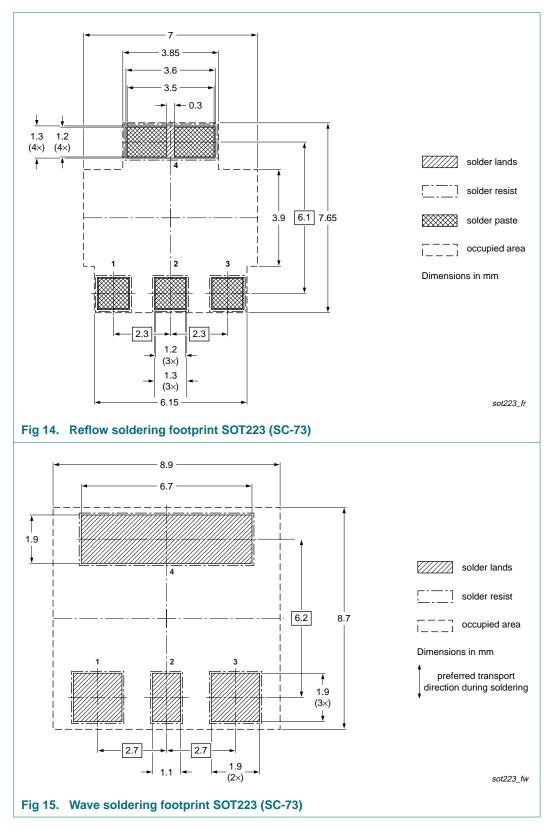
The indicated -xxx are the last three digits of the 12NC ordering code.[1]

Type number	Package	Description	Packing	quantity
			1000	4000
PBHV8540Z	SOT223	8 mm pitch, 12 mm tape and reel	-115	-135

[1] For further information and the availability of packing methods, see <u>Section 14</u>.

500 V, 0.5 A NPN high-voltage low V_{CEsat} (BISS) transistor

11. Soldering



500 V, 0.5 A NPN high-voltage low V_{CEsat} (BISS) transistor

12. Revision history

Table 9.Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
PBHV8540Z_2	20090114	Product data sheet	-	PBHV8540Z_1
Modifications:	• Figure 5: am	ended		
	 Section 13 "L 	_egal information": updated		
PBHV8540Z_1	20080207	Product data sheet	-	-

13. Legal information

13.1 Data sheet status

Document status ^{[1][2]}	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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PBHV8540Z

500 V, 0.5 A NPN high-voltage low V_{CEsat} (BISS) transistor

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